

## IGBT MODULE ( S-Series )

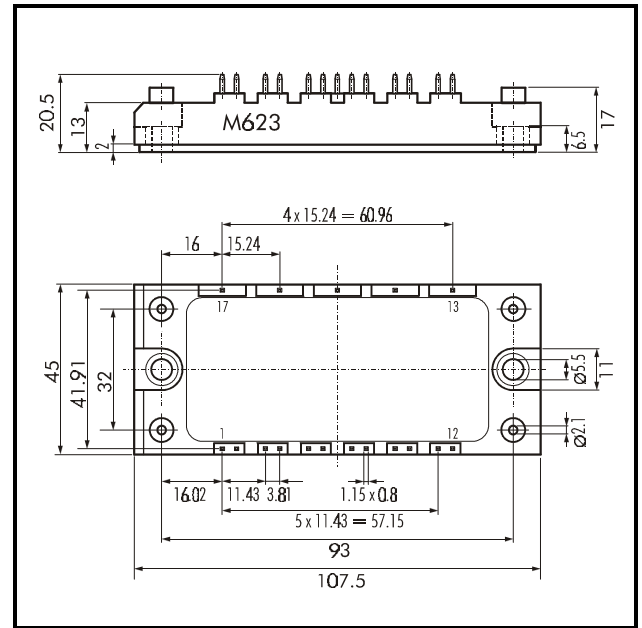
### ■ Features

- NPT-Technology
- Solderable Package
- Square SC SOA at 10 x I<sub>C</sub>
- High Short Circuit Withstand-Capability
- Small Temperature Dependence of the Turn-Off Switching Loss
- Low Losses And Soft Switching

### ■ Applications

- High Power Switching
- A.C. Motor Controls
- D.C. Motor Controls
- Uninterruptible Power Supply

## ■ Outline Drawing



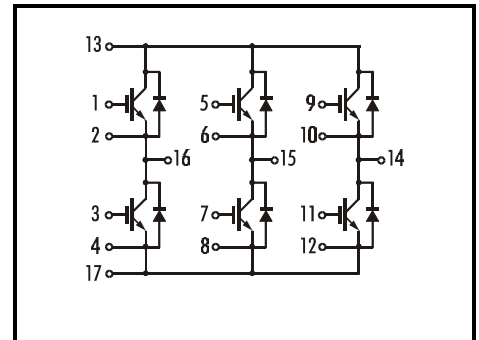
## ■ Maximum Ratings and Characteristics

### • Absolute Maximum Ratings ( T<sub>c</sub>=25°C )

Items	Symbols	Ratings	Units	
Collector-Emitter Voltage	V <sub>CEs</sub>	1200	V	
Gate -Emitter Voltage	V <sub>GES</sub>	± 20		
Collector Current	Continuous	25°C / 80°C	I <sub>C</sub>	A
	1ms	25°C / 80°C	I <sub>C PULSE</sub>	
	Continuous		-I <sub>C</sub>	
	1ms		-I <sub>C PULSE</sub>	
Max. Power Dissipation	P <sub>C</sub>	75	W	
Operating Temperature	T <sub>j</sub>	+150	°C	
Storage Temperature	T <sub>stg</sub>	-40 ~ +125		
Isolation Voltage	V <sub>is</sub>	2500	V	
Screw Torque	Mounting*	3.5	Nm	

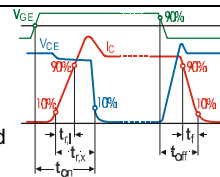
Note: \*Recommendable Value; 2.5 - 3.5 Nm (M5)

## ■ Equivalent Circuit



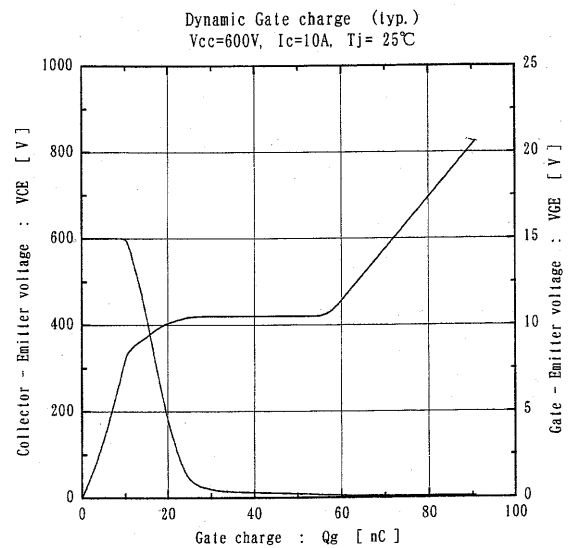
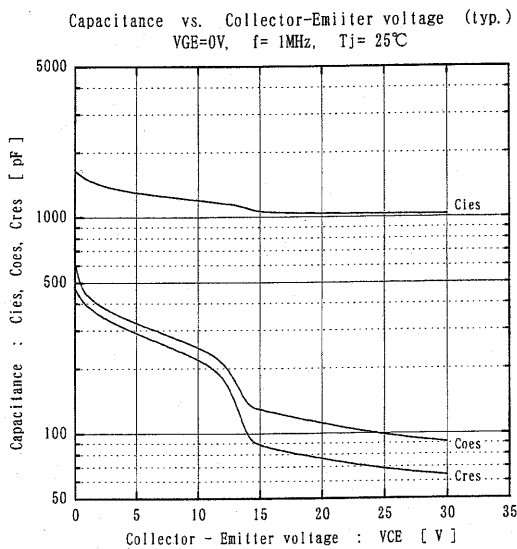
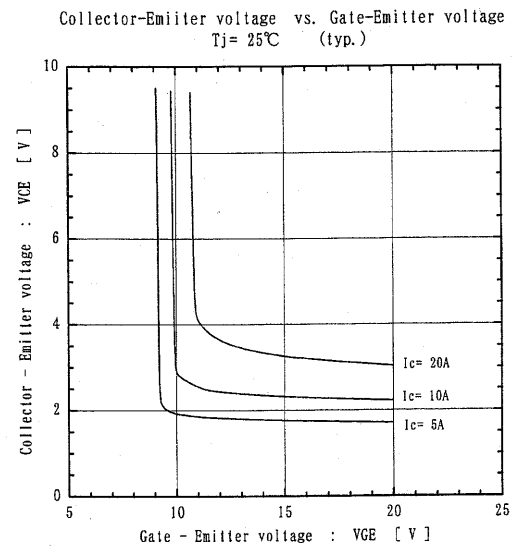
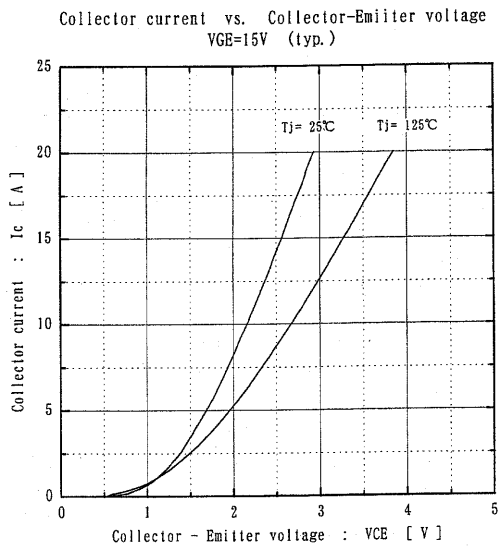
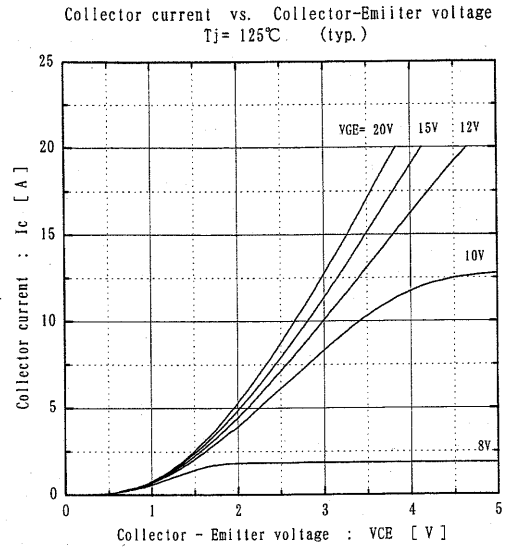
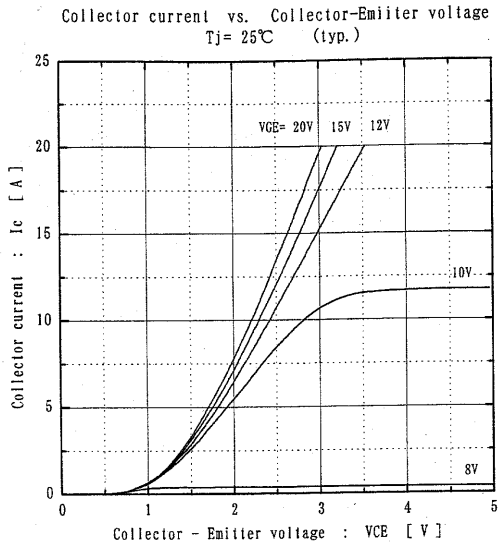
### • Electrical Characteristics ( at T<sub>j</sub>=25°C )

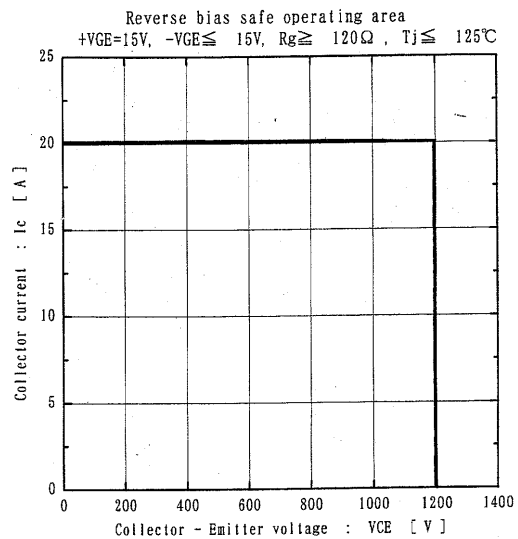
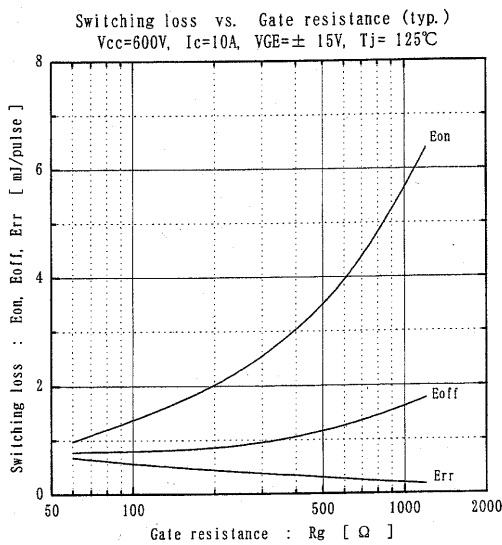
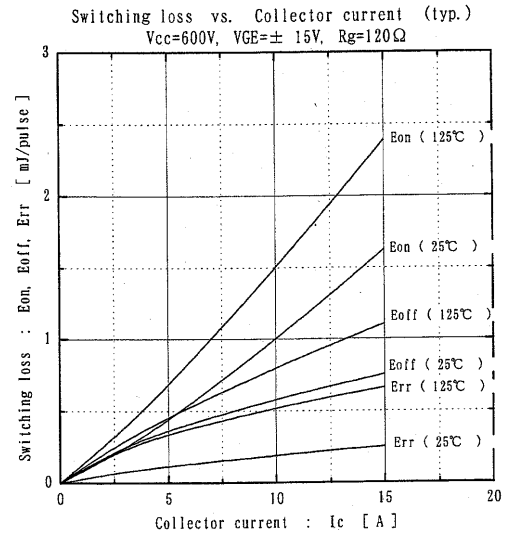
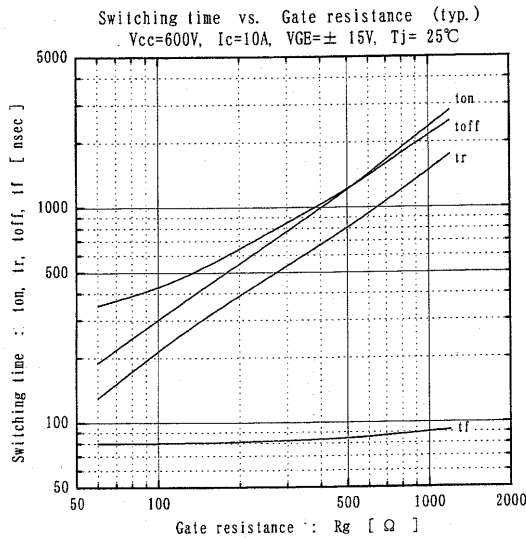
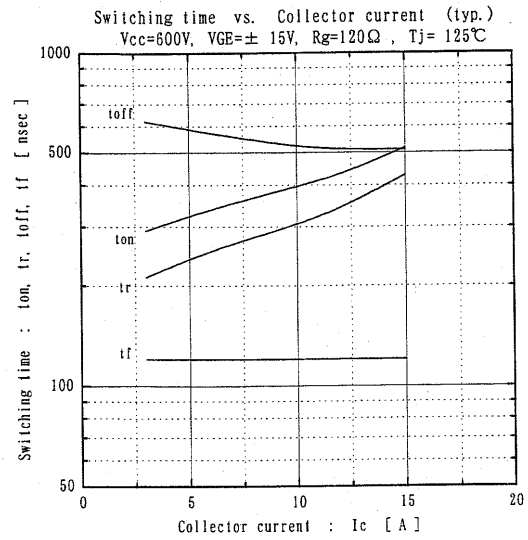
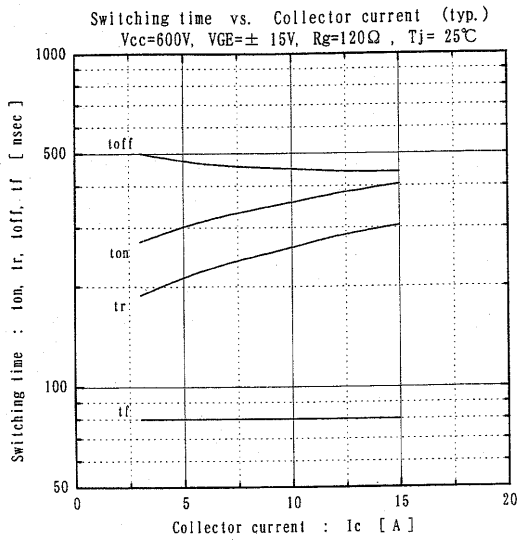
Items	Symbols	Test Conditions	Min.	Typ.	Max.	Units
Zero Gate Voltage Collector Current	I <sub>CEs</sub>	V <sub>GE</sub> =0V V <sub>CE</sub> =1200V			1.0	mA
Gate-Emitter Leakage Current	I <sub>GES</sub>	V <sub>CE</sub> =0V V <sub>GE</sub> =± 20V			200	nA
Gate-Emitter Threshold Voltage	V <sub>GE(th)</sub>	V <sub>GE</sub> =20V I <sub>C</sub> =10mA	5.5	7.2	8.5	V
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	V <sub>GE</sub> =15V I <sub>C</sub> =10A; T <sub>j</sub> = 25°C		2.3	2.6	
		V <sub>GE</sub> =15V I <sub>C</sub> =10A; T <sub>j</sub> =125°C		2.8		
Input Capacitance	C <sub>ies</sub>	V <sub>GE</sub> =0V		1200		pF
Output Capacitance	C <sub>oes</sub>	V <sub>CE</sub> =10V		250		
Reverse Transfer Capacitance	C <sub>res</sub>	f=1MHz		220		
Turn-on Time	t <sub>ON</sub>	V <sub>CC</sub> =600V		0.35	1.2	μs
	t <sub>r,x</sub>	I <sub>C</sub> =10A		0.25	0.6	
	t <sub>r,i</sub>	V <sub>GE</sub> =± 15V		0.10		
Turn-off Time	t <sub>OFF</sub>	R <sub>G</sub> =120Ω		0.45	1.0	μs
	t <sub>f</sub>	Inductive Load		0.08	0.3	
Diode Forward On-Voltage	V <sub>F</sub>	I <sub>F</sub> =10A; V <sub>GE</sub> =0V; T <sub>j</sub> = 25°C		2.5	3.3	V
		I <sub>F</sub> =10A; V <sub>GE</sub> =0V; T <sub>j</sub> =125°C		2.0		
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> =10A			350	ns



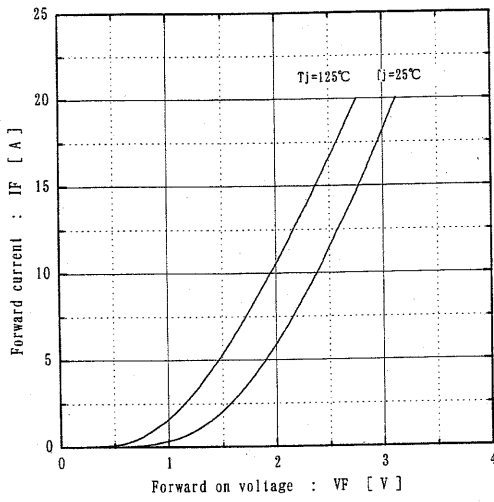
### • Thermal Characteristics

Items	Symbols	Test Conditions	Min.	Typ.	Max.	Units
Thermal Resistance	R <sub>th(j-c)</sub>	IGBT			1.67	°C/W
	R <sub>th(j-e)</sub>	Diode			2.78	
	R <sub>th(c-f)</sub>	With Thermal Compound		0.05		

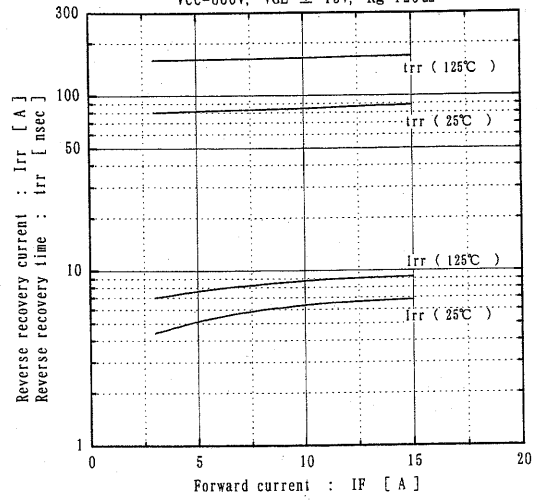




Forward current vs. Forward on voltage (typ.)



Reverse recovery characteristics (typ.)  
Vcc=600V, VGE=± 15V, Rg=120Ω



Transient thermal resistance

